



Product Change Notification

Change Notification #: 117629 - 00

**Change Title: Intel(R) Ethernet Network Adapter X710-DA2 for OCP NIC 3.0
Intel(R) Ethernet Network Adapter X710-DA4 for OCP NIC 3.0 ,
PCN 117629-00, Product Design, Label,
Firmware Update**

Date of Publication: June 15, 2020

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 20, 2020
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Description of Change to the Customer:

The products listed in the products affected table below will undergo the following changes:

1. Intel will update the NVM (non-volatile memory) image being programmed onto these cards to the latest firmware available for the OCP NIC 3.0 adapters which provides additional manageability features as defined in the OCP NIC 3.0 specification.
 - Management Component Transport Protocol. Updates Management Component Transport Protocol (MCTP) Base to version 1.3 (DSP0236 1.3 compliant).
 - MAC Address Provisioning: Provisions one or more MAC addresses per NC-SI capable device that can be used for out of band management.
 - Temperature Reporting: Reports temperature of Intel(R) Ethernet Controller and optical modules installed on the adapter.
 - Estimated power consumption Reporting: Reports estimated power consumption of adapter, excluding transceiver modules.
2. Label changes:
 - Intel will update the Intel Serial Number label to change the Intel PBA number to reflect the "Post Change PBA" part number, as documented in the "Products Affected / Intel Ordering Codes" section.
 - Intel will update all the Intel outer box/disti labels on packaging to change Intel Top Assembly number to reflect the new "Post Change TA" part number, as documented in the "Products Affected / Intel Ordering Codes" section.

Customer Impact of Change and Recommended Action:

Intel anticipates no functional impact to customer but encourages customer to understand the changes and determine the impact to their operations if any.

You can expect to receive mixed inventory until current inventory levels have been depleted.
Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel(R) Ethernet Network Adapter X710-DA2 for OCP NIC 3.0	X710DA2OCPV3	979095	K55785-001	K35346-001	K55785-002	K35346-002
Intel(R) Ethernet Network Adapter X710-DA2 for OCP NIC 3.0	X710DA2OCPV3G1P	979097	K53124-002	K20660-008	K53124-003	K20660-009
Intel(R) Ethernet Network Adapter X710-DA4 for OCP NIC 3.0	X710DA4OCPV3	979098	K55791-001	K35347-002	K55791-002	K35347-003
Intel(R) Ethernet Network Adapter X710-DA4 for OCP NIC 3.0	X710DA4OCPV3G1P	979099	K55986-002	K20661-006	K55986-003	K20661-007

PCN Revision History:

Date of Revision:

June 15, 2020

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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